



Commemorative Issue in Honor of Prof. Dr. Manoj Gupta on the Occasion of 60th Birthday

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submissions:

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Message from the Guest Editors

We are pleased to announce a Special Issue in honor of Professor Manoj Gupta for his 60th birthday.

Dr Manoj Gupta received his PhD degree from the University of California, Irvine, USA, in 1992 and is currently an Associate Professor with the Department of Mechanical Engineering at the National University of Singapore. In August 2017, he was highlighted among the Top 1% Scientist of the World Position by The Universal Scientific Education and Research Network and among the top 2.5% by ResearchGate and Top 1% in the Stanford list of researchers. He has published over 600 peer-reviewed journal papers and owns two US patents. His current h-index is 72, RG index 48, and his citation number is greater than 19,000.

In honor and recognition of Professor Gupta's outstanding career contributions to the field of light metals, metal matrix composites, and innovations in materials processing, we would like to invite you to submit an article for the Special Issue to be published in *Technologies*. Research articles or review papers relating to metal-based materials, metal matrix composites, and innovation in materials processing are welcome for publication in this Special Issue.





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Editor-in-Chief

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Message from the Editor-in-Chief

Technologies, provides a single focus for reporting on developments of all technologies, regardless of their application. It is our intention that *Technologies* becomes the journal of choice for both researchers wanting to publish their work and technologists wishing to exploit the high quality research across a wide range of potential applications. Through its open access policy, its quick publication cycle, *Technologies* will facilitate the rapid uptake and development of the research presented, ultimately providing benefit to the wider society.

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